PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
John Keith NELSON	03/21/2005
Linda Sue SCHADLER FEIST	03/21/2005

RECEIVING PARTY DATA

Name:	RENSSELAER POLYTECHNIC INSTITUTE
Street Address:	110 8th Street
City:	Troy
State/Country:	NEW YORK
Postal Code:	12180

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11044489

CORRESPONDENCE DATA

Fax Number: (440)808-0657

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 440.808.0011

Email: cleveland@patentandtm.com

Correspondent Name: Joseph G. Curatolo

Address Line 1: 24500 Center Ridge Road

Address Line 2: Suite 280

Address Line 4: Cleveland, OHIO 44145

NAME OF SUBMITTER: Joseph G. Curatolo

Total Attachments: 2

source=EPR.P1260 Inv-Ren - 1#page1.tif source=EPR.P1260 Inv-Ren - 2#page1.tif

OP \$40.00

PATENT REEL: 015905 FRAME: 0036

ASSIGNMENT

We, John Keith NELSON, residing at 2329 Knolls View Drive, in the City of Niskayuna, the State of New York, and Linda Sue SCHADLER FEIST, residing at 11 Crimson Oak Court, residing in the City of Niskayuna, the State of New York, have invented certain new and useful improvements in Nanostructured Dielectric Composite Materials, and Rensselaer Polytechnic Institute, an educational institution chartered under the laws of the State of New York, having an office at 110 8th Street, Troy, New York 12180, Country of the United States of America, desires to acquire the rights to this invention.

In consideration of one dollar, receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we, John Keith NELSON, and Linda Sue SCHADLER FEIST, hereby sell, assign, and transfer to Rensselaer Polytechnic Institute, its successors and assigns, the entire right, title, and interest in and to this invention relating to Nanostructured Dielectric Composite Materials and any improvements thereon; the so-entitled application for United States Letters Patent which was filed on January 27, 2005, bears United States Serial No. 11/044,489; any and all continuations, continuations-in-part, divisions and renewals thereof; all United States Letters Patent granted thereon; all reissues, reexaminations or extensions thereof; and any and all Letters Patents on said invention, and applications therefor, including all rights to claim priority, in any and all countries foreign to the United States of America.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all United States Letters Patent on said invention and application, or applications resulting therefrom, to Rensselaer Polytechnic Institute, as assignee of the entire right, title, and interest.

Page 1 of 2

We further agree that during and subsequent to our employment with, on request and without further consideration, but at the sole expense of Rensselaer Polytechnic Institute, we will with respect to this invention and this application or any subsequent application on this invention communicate to counsel for Rensselaer Polytechnic Institute, its successors and assigns all facts known to me; testify in all legal proceedings; sign all lawful papers; execute all applications; make all rightful oaths; generally do everything possible to aid Rensselaer Polytechnic Institute, its successors and assigns to obtain and enforce lawful patent protection for said invention in the United States and countries foreign thereto; and vest the entire right, title and interest in and to said invention and any and all applications for letters patent therefor and letters patent thereon in Rensselaer Polytechnic Institute, its successors and assigns.

Executed this 21 4	day of Mard, 20	20
Trulin January	W. Nola	03/21/05
Witness	John Keith NELSON	'Date
Julain China	Fundo I Schooller Teist	3/21/05
Witness	Linda Sue SCHADLER FEIST	Date

RECORDED: 04/15/2005